



# PMEG120G30ELP

120 V, 3 A Silicon Germanium (SiGe) rectifier

26 May 2020

Product data sheet

## 1. General description

Silicon Germanium (SiGe) rectifier encapsulated in a CFP5 (SOD128) small and flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

| Features                                                                                                                                                                                                                                                                                                     | Benefits                                                                                                                                                                                                              |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <ul style="list-style-type: none"><li>• Low forward voltage and low <math>Q_{rr}</math></li><li>• Extremely low leakage current</li><li>• Thermal stability up to 175 °C junction temperature</li><li>• Fast and smooth switching</li><li>• Low parasitic capacitance</li><li>• AEC-Q101 qualified</li></ul> | <ul style="list-style-type: none"><li>• Excellent efficiency</li><li>• Extraordinary safe operating area</li><li>• Minimal impact on Electro-Magnetic Compatibility (EMC) allowing simplified certification</li></ul> |

## 3. Applications

- High-efficiency power conversion
  - Automotive LED lighting
  - Engine control unit
  - Server power supply
  - Base station power supply
- Reverse polarity protection
- OR-ing

## 4. Quick reference data


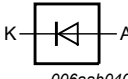
Table 1. Quick reference data

| Symbol      | Parameter               | Conditions                                                       | Min | Typ | Max | Unit    |
|-------------|-------------------------|------------------------------------------------------------------|-----|-----|-----|---------|
| $I_{F(AV)}$ | average forward current | $\delta = 0.5$ ; square wave; $f = 20$ kHz; $T_{sp} \leq 162$ °C | -   | -   | 3   | A       |
| $V_R$       | reverse voltage         | $T_j = 25$ °C                                                    | -   | -   | 120 | V       |
| $V_F$       | forward voltage         | $I_F = 3$ A; $T_j = 25$ °C; pulsed                               | [1] | 770 | 840 | mV      |
| $I_R$       | reverse current         | $V_R = 120$ V; $T_j = 25$ °C; pulsed                             | [1] | 0.5 | 30  | nA      |
|             |                         | $V_R = 120$ V; $T_j = 150$ °C; pulsed                            | [1] | 30  | 300 | $\mu$ A |

[1] Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline                                                                                 | Graphic symbol                                                                                   |
|-----|--------|-------------|----------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------|
| 1   | K      | cathode     | <br>CFP5 (SOD128) | <br>006aab040 |
| 2   | A      | anode       |                                                                                                    |                                                                                                  |

## 6. Ordering information

Table 3. Ordering information

| Type number   | Package |                                                                                        |         |
|---------------|---------|----------------------------------------------------------------------------------------|---------|
|               | Name    | Description                                                                            | Version |
| PMEG120G30ELP | CFP5    | plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body | SOD128  |

## 7. Marking

Table 4. Marking codes

| Type number   | Marking code |
|---------------|--------------|
| PMEG120G30ELP | E9           |

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Attention: Stress above one of these maximum values may cause irreversible damage to the device.

| Symbol      | Parameter                           | Conditions                                                                      |     | Min | Max  | Unit |
|-------------|-------------------------------------|---------------------------------------------------------------------------------|-----|-----|------|------|
| $V_R$       | reverse voltage                     | $T_j = 25\text{ °C}$                                                            |     | -   | 120  | V    |
| $I_F$       | forward current                     | $\delta = 1; T_{sp} \leq 158\text{ °C}$                                         |     | -   | 4.2  | A    |
| $I_{F(AV)}$ | average forward current             | $\delta = 0.5$ ; square wave; $f = 20\text{ kHz}$ ; $T_{sp} \leq 162\text{ °C}$ |     | -   | 3    | A    |
| $I_{FSM}$   | non-repetitive peak forward current | $t_p = 8.3\text{ ms}$ ; half sine wave; $T_{j(\text{init})} = 25\text{ °C}$     |     | -   | 85   | A    |
| $P_{tot}$   | total power dissipation             | $T_{amb} \leq 25\text{ °C}$                                                     | [1] | -   | 0.75 | W    |
|             |                                     |                                                                                 | [2] | -   | 1.2  | W    |
| $T_j$       | junction temperature                |                                                                                 |     | -   | 175  | °C   |
| $T_{amb}$   | ambient temperature                 |                                                                                 |     | -55 | 175  | °C   |
| $T_{stg}$   | storage temperature                 |                                                                                 |     | -65 | 175  | °C   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol         | Parameter                                        | Conditions  |     | Min | Typ | Max | Unit |
|----------------|--------------------------------------------------|-------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air | [1] | -   | -   | 200 | K/W  |
|                |                                                  |             | [2] | -   | -   | 120 | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |             | [3] | -   | -   | 12  | K/W  |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [3] Soldering point of cathode tab.

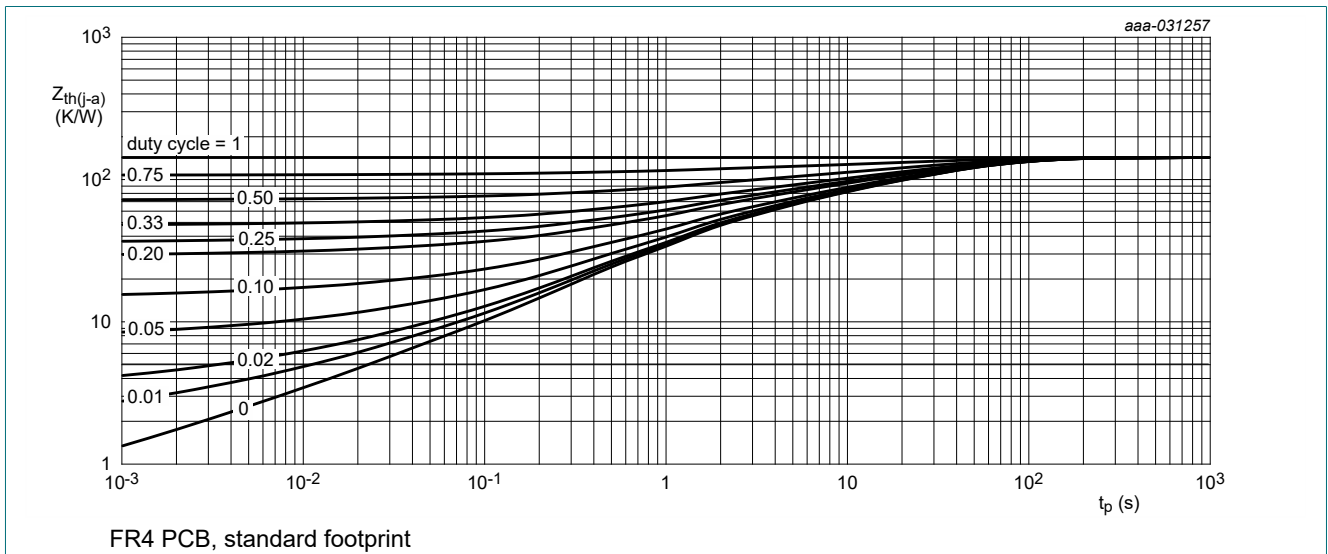


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

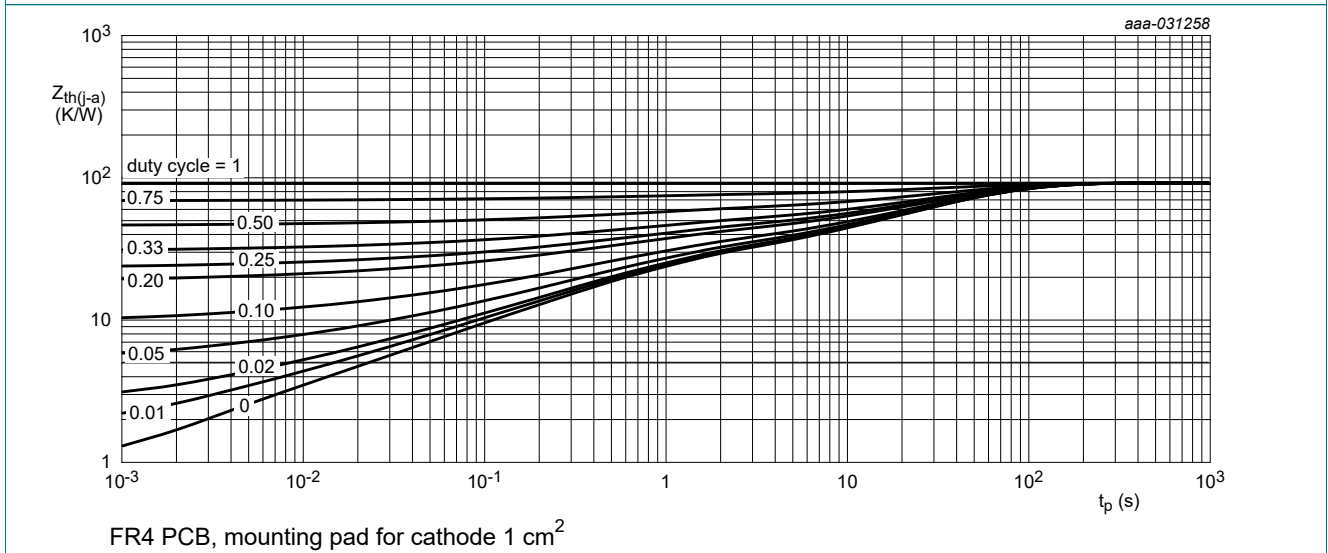


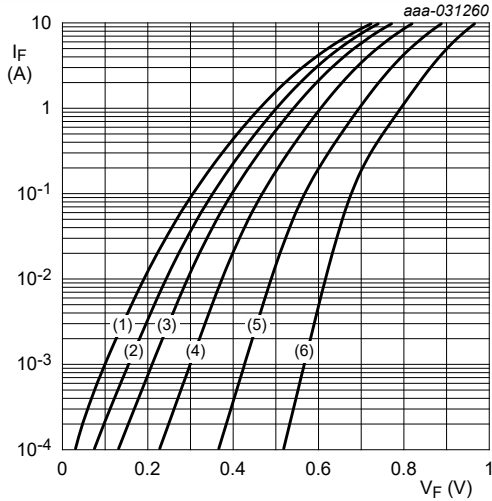
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

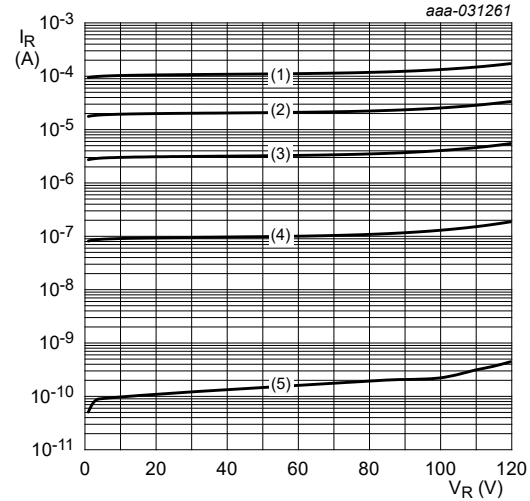
| Symbol      | Parameter                           | Conditions                                                                                                              |     | Min | Typ | Max | Unit          |
|-------------|-------------------------------------|-------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|-----|---------------|
| $V_{(BR)R}$ | reverse breakdown voltage           | $I_R = 1 \text{ mA}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$                                                        | [1] | 120 | -   | -   | V             |
| $V_F$       | forward voltage                     | $I_F = 0.1 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$ ; pulsed                                                      | [1] | -   | 570 | 660 | mV            |
|             |                                     | $I_F = 0.5 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$ ; pulsed                                                      | [1] | -   | 655 | 740 | mV            |
|             |                                     | $I_F = 1 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$ ; pulsed                                                        | [1] | -   | 700 | 780 | mV            |
|             |                                     | $I_F = 2 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$ ; pulsed                                                        | [1] | -   | 745 | 820 | mV            |
|             |                                     | $I_F = 3 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$ ; pulsed                                                        | [1] | -   | 770 | 840 | mV            |
|             |                                     | $I_F = 3 \text{ A}$ ; $T_j = -40 \text{ }^\circ\text{C}$ ; pulsed                                                       | [1] | -   | 860 | 950 | mV            |
|             |                                     | $I_F = 3 \text{ A}$ ; $T_j = 125 \text{ }^\circ\text{C}$ ; pulsed                                                       | [1] | -   | 630 | 730 | mV            |
| $I_R$       | reverse current                     | $V_R = 120 \text{ V}$ ; $T_j = 25 \text{ }^\circ\text{C}$ ; pulsed                                                      | [1] | -   | 0.5 | 30  | nA            |
|             |                                     | $V_R = 120 \text{ V}$ ; $T_j = 125 \text{ }^\circ\text{C}$ ; pulsed                                                     | [1] | -   | 5   | 60  | $\mu\text{A}$ |
|             |                                     | $V_R = 120 \text{ V}$ ; $T_j = 150 \text{ }^\circ\text{C}$ ; pulsed                                                     | [1] | -   | 30  | 300 | $\mu\text{A}$ |
| $C_d$       | diode capacitance                   | $V_R = 1 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ }^\circ\text{C}$                                           |     | -   | 103 | -   | pF            |
|             |                                     | $V_R = 10 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ }^\circ\text{C}$                                          |     | -   | 41  | -   | pF            |
| $t_{rr}$    | reverse recovery time step recovery | $I_F = 0.5 \text{ A}$ ; $I_R = 1 \text{ A}$ ; $I_{R(\text{meas})} = 0.25 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$ |     | -   | 6   | -   | ns            |
|             | reverse recovery time ramp recovery | $dI_F/dt = 100 \text{ A}/\mu\text{s}$ ; $I_F = 1 \text{ A}$ ; $V_R = 30 \text{ V}$ ; $T_j = 25 \text{ }^\circ\text{C}$  |     | -   | 11  | -   | ns            |
| $I_{RM}$    | peak reverse recovery current       |                                                                                                                         |     | -   | 0.6 | -   | A             |
| $Q_{rr}$    | reverse recovery charge             |                                                                                                                         |     | -   | 4   | -   | nC            |
| $V_{FRM}$   | peak forward recovery voltage       | $I_F = 0.5 \text{ A}$ ; $dI_F/dt = 20 \text{ A}/\mu\text{s}$ ; $T_j = 25 \text{ }^\circ\text{C}$                        |     | -   | 650 | -   | mV            |

[1] Very short pulse, in order to maintain a stable junction temperature.



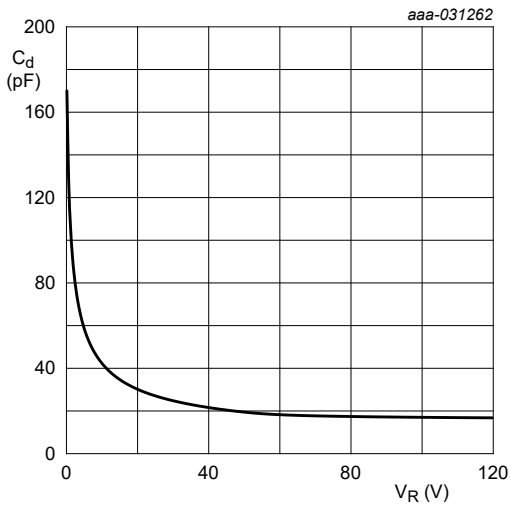
pulsed condition  
 (1)  $T_j = 175^\circ\text{C}$   
 (2)  $T_j = 150^\circ\text{C}$   
 (3)  $T_j = 125^\circ\text{C}$   
 (4)  $T_j = 85^\circ\text{C}$   
 (5)  $T_j = 25^\circ\text{C}$   
 (6)  $T_j = -40^\circ\text{C}$

Fig. 3. Forward current as a function of forward voltage; typical values



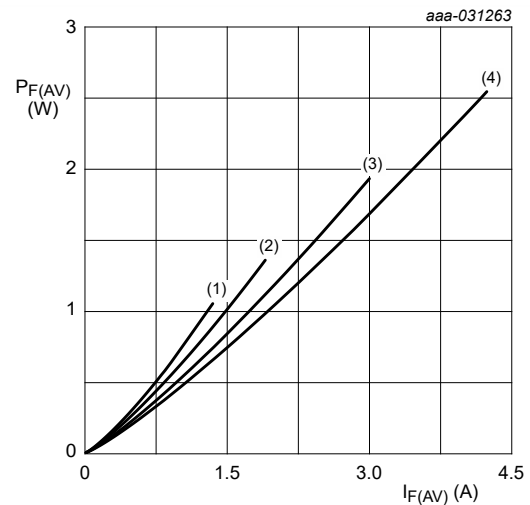
pulsed condition  
 (1)  $T_j = 175^\circ\text{C}$   
 (2)  $T_j = 150^\circ\text{C}$   
 (3)  $T_j = 125^\circ\text{C}$   
 (4)  $T_j = 85^\circ\text{C}$   
 (5)  $T_j = 25^\circ\text{C}$

Fig. 4. Reverse current as a function of reverse voltage; typical values



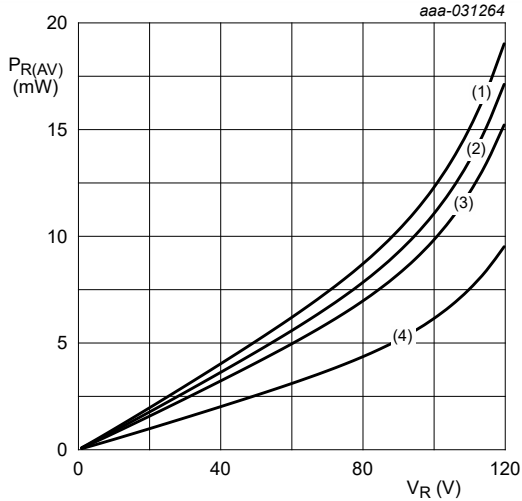
$f = 1\text{ MHz}; T_{\text{amb}} = 25^\circ\text{C}$

Fig. 5. Diode capacitance as a function of reverse voltage; typical values



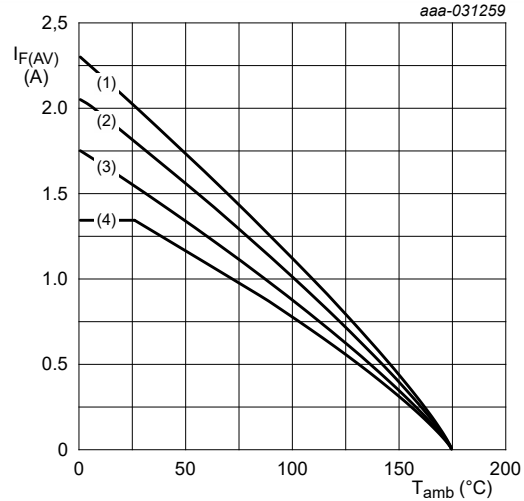
$T_j = 175^\circ\text{C}$   
 (1)  $\delta = 0.1$   
 (2)  $\delta = 0.2$   
 (3)  $\delta = 0.5$   
 (4)  $\delta = 1$ ; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



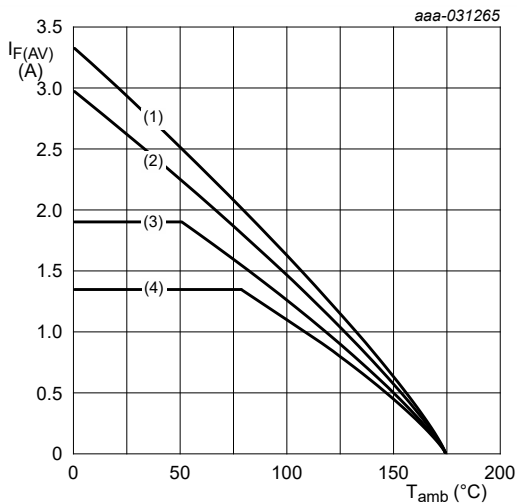
$T_j = 175\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.9$   
 (3)  $\delta = 0.8$   
 (4)  $\delta = 0.5$

**Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values**



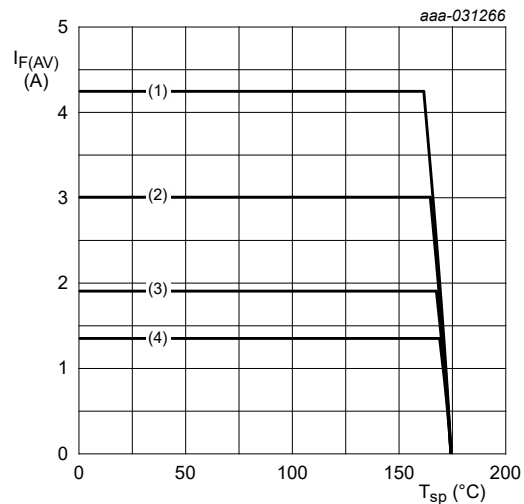
FR4 PCB, standard footprint  
 $T_j = 175\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

**Fig. 8. Average forward current as a function of ambient temperature; typical values**



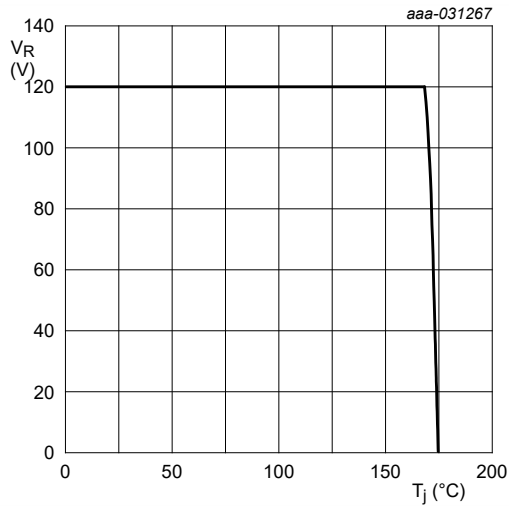
FR4 PCB, mounting pad for cathode  $1\text{ cm}^2$   
 $T_j = 175\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

**Fig. 9. Average forward current as a function of ambient temperature; typical values**



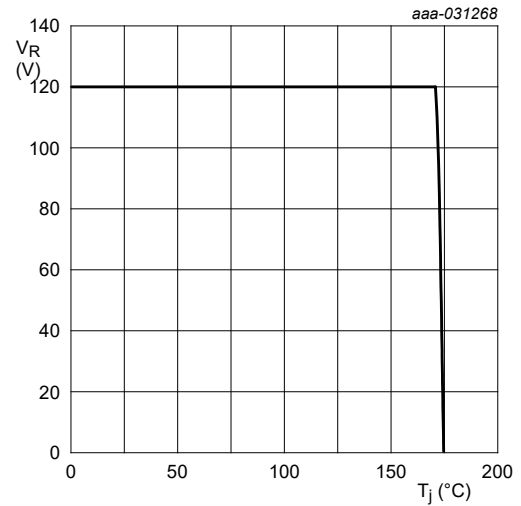
$T_j = 175\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

**Fig. 10. Average forward current as a function of solder point temperature; typical values**



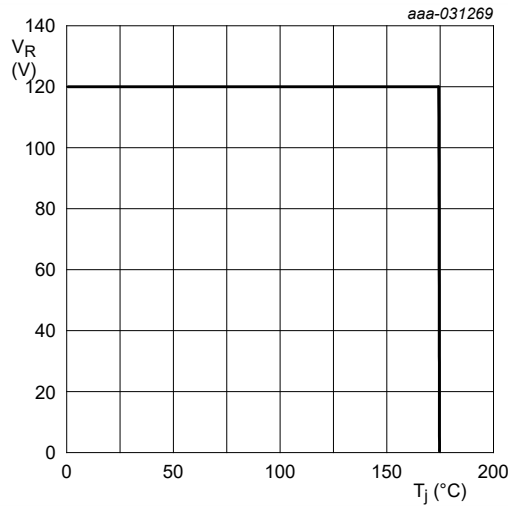
FR4 PCB, standard footprint  
 $R_{th} = 200 \text{ K/W}$

**Fig. 11. Derated maximum reverse voltage as a function of junction temperature; typical values**



FR4 PCB, mounting pad for cathode  $1 \text{ cm}^2$   
 $R_{th} = 120 \text{ K/W}$

**Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values**



Soldering point of cathode tab  
 $R_{th} = 12 \text{ K/W}$

**Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values**

### 11. Test information

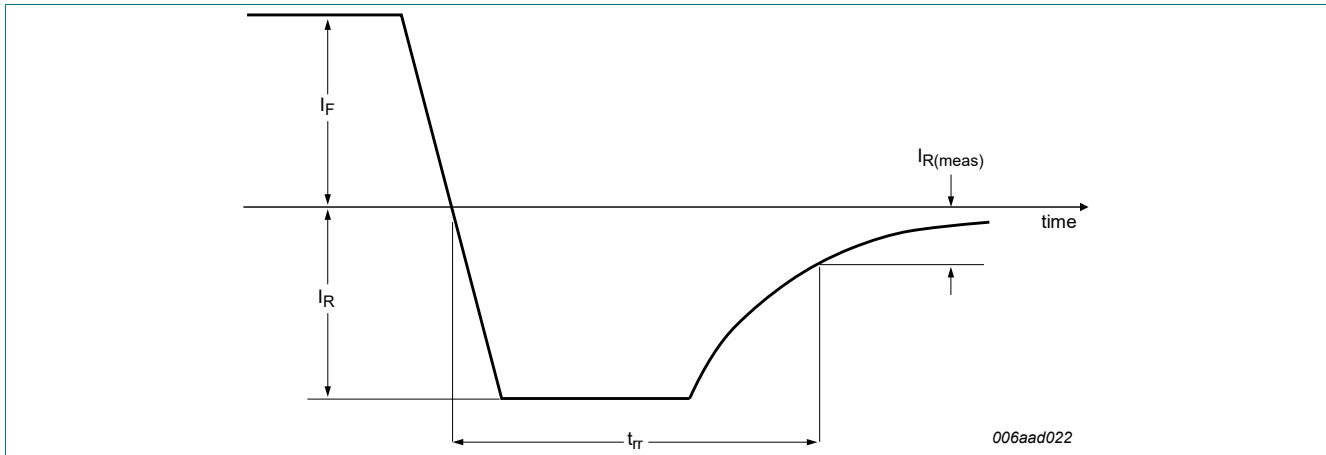


Fig. 14. Reverse recovery definition; step recovery

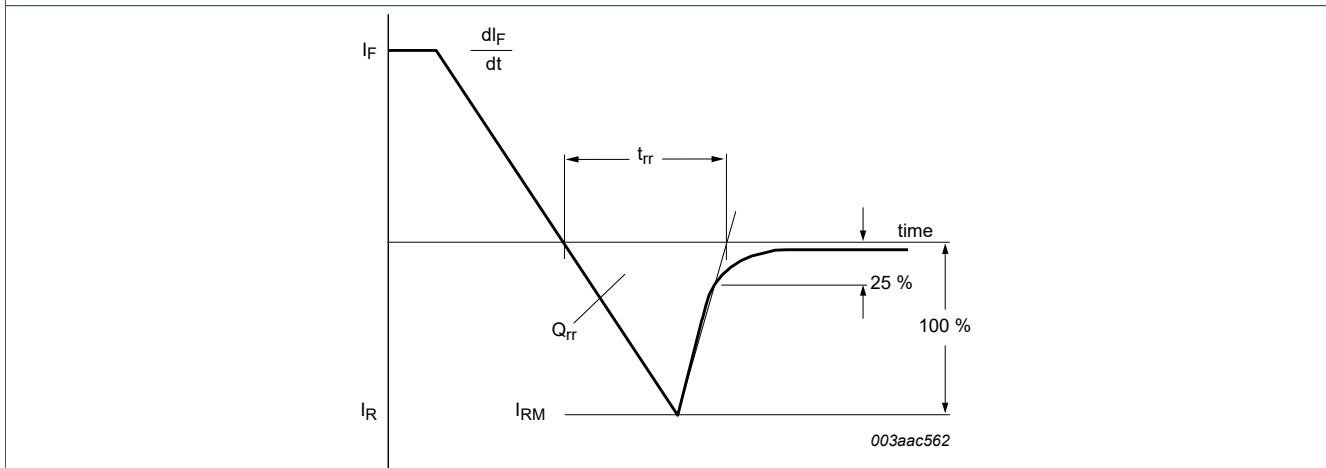


Fig. 15. Reverse recovery definition; ramp recovery

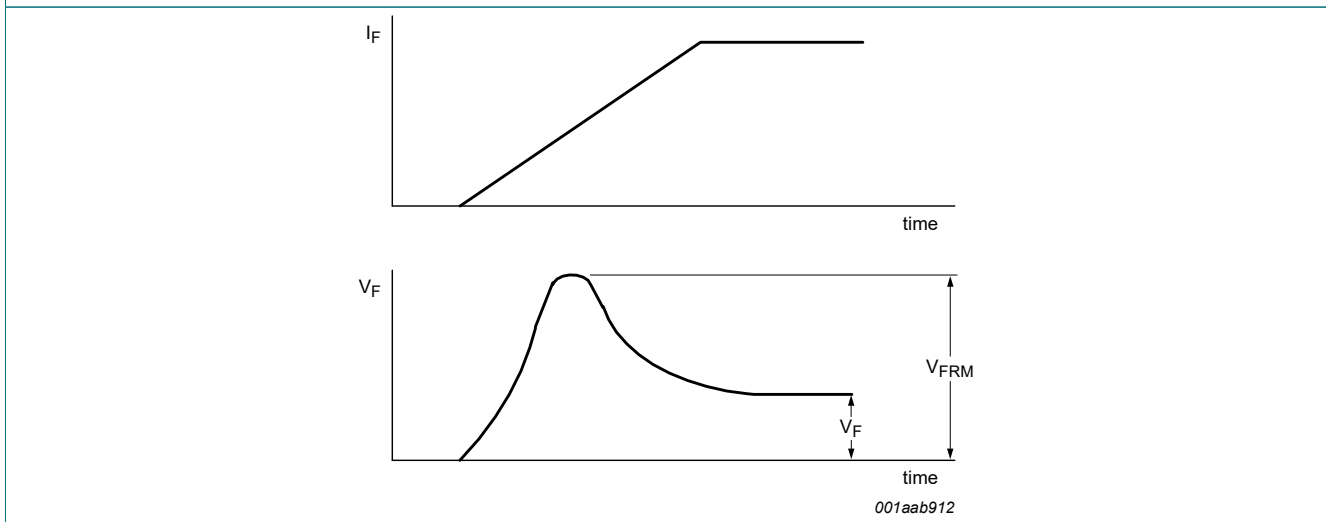


Fig. 16. Forward recovery definition



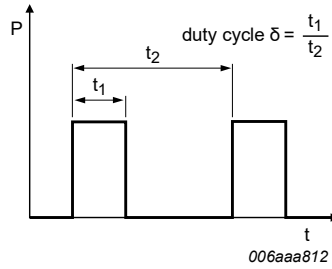


Fig. 17. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$$I_{F(AV)} = I_M \times \delta$$

with  $I_M$  defined as peak current

$$I_{RMS} = I_{F(AV)} \text{ at DC, and } I_{RMS} = I_M \times \sqrt{\delta}$$

with  $I_{RMS}$  defined as RMS current.

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline

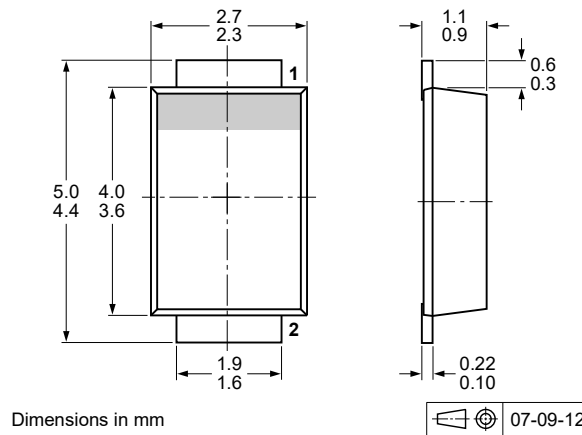


Fig. 18. Package outline CFP5 (SOD128)

### 13. Soldering

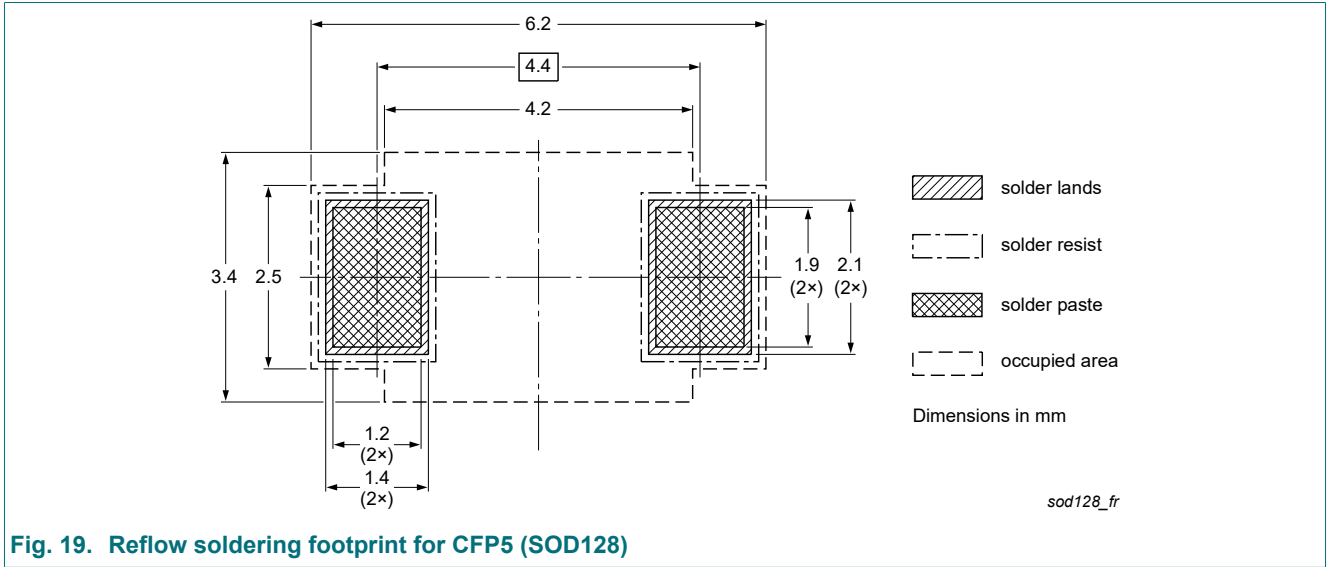
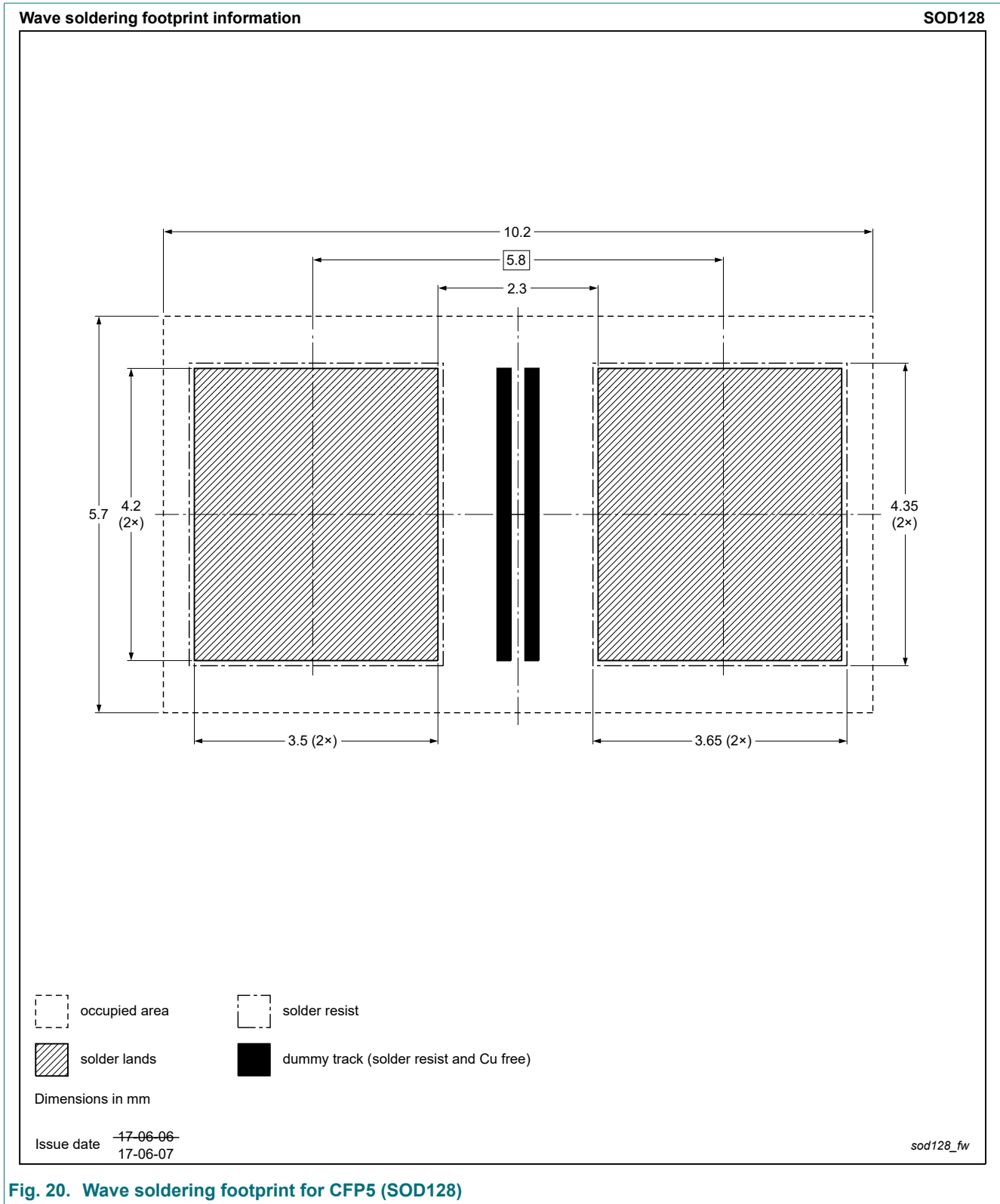


Fig. 19. Reflow soldering footprint for CFP5 (SOD128)



**Fig. 20. Wave soldering footprint for CFP5 (SOD128)**

## 14. Mounting

This device is sensitive to Electro Static Discharge (ESD). Observe precautions for handling electrostatic sensitive devices. Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

## 15. Revision history

Table 8. Revision history

| Data sheet ID     | Release date | Data sheet status  | Change notice | Supersedes |
|-------------------|--------------|--------------------|---------------|------------|
| PMEG120G30ELP v.1 | 20200526     | Product data sheet | -             | -          |

## 16. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition                                                                            |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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